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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# RENESAS

M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) SINGLE-CHIP 16-BIT CMOS MICROCOMPUTER

REJ03B0071-0051 Rev.0.51 Jul.25, 2006

# 1. Overview

The M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) is a single-chip control MCU, fabricated using high-performance silicon gate CMOS technology, embedding the M16C/60 Series CPU core. The M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) is housed in 42-pin and 48-pin plastic molded packages. With a 1M byte address space, this MCU combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed. The M16C/26A Group (M16C/26B, M16C/26T) has a multiplier and DMAC adequate for office automation, communication devices and industrial equipment, and other high-speed processing applications.

# **1.1 Applications**

Audio, cameras, office/communications/portable/ equipment, air-conditioning equipment, home appliances, etc.



# **1.2 Performance Outline**

**Table 1.1** and **1.2** outline performance overview of the M16C/26A Group (M16C/26A, M16C/26B, M16C/26T).

	Item	Specification			
CPU	Basic instructions	91 instructions			
	Minimun instruction	41.7 ns (f(BCLK) = 24MHz <sup>(4)</sup> , VCC = 4.2 to 5.5 V) (M16C/26B)			
	execution time	50 ns (f(BCLK) = 20MHz, Vcc = 3.0 to 5.5 V) (M16C/26A, M16C/26B, M16C/26T(T-ver.))			
		100 ns (f(BCLK) = 10MHz, Vcc = 2.7 to 5.5 V) (M16C/26A , M16C/26B)			
		50 ns (f(BCLK) = 20MHz, Vcc = 4.2 to 5.5 V -40 to 105°C) (M16C/26T(V-ver.))			
		62.5 ns (f(BCLK) = 16MHz, Vcc = 4.2 to 5.5 V -40 to 125°C) (M16C/26T(V-ver.))			
	Operating mode	Single-chip mode			
	Address space	1 Mbyte			
	Memory capacity	See 1.4 Product Information			
Peripheral	I/O ports	39 I/O pins			
Function	Multifunction timers	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels			
		Three-phase motor control timer			
	Serial I/O	2 channels (UART, clock synchronous serial I/O)			
		1 channel (UART, clock synchronous, I <sup>2</sup> C bus <sup>(1)</sup> , or IEBus <sup>(2)</sup> )			
	A/D converter	10 bit A/D Converter : 1 circuit, 12 channels			
	DMAC	2 channels			
	CRC calcuration circuit	1 circuit (CRC-CCITT and CRC-16) with MSB/LSB selectable			
	Watchdog timer	15 bits x 1 channel (with prescaler)			
	Interrupts	20 internal and 8 external sources, 4 software sources,			
		Interrupt priority level: 7			
	Clock generation circuit	4 circuits			
		Main clock oscillation circuit(*), Sub-clock oscillation circuit(*)			
		On-chip oscillator, PLL frequency synthesizer			
		(*)Equipped with a built-in feedback resister.			
	Oscillation stop detection	Main clock oscillation stop, re-oscillation detection function			
	Voltage detection circuit	On-chip (M16C/26A, M16C/26B), not on-chip (M16C/26T)			
Electrical	Power supply voltage	$Vcc = 4.2 \text{ to } 5.5 \text{ V} (f(BCLK) = 24 \text{ MHz})^{(4)}$ (M16C/26B)			
Characteristics		Vcc = 3.0 to 5.5 V (f(BCLK) = 20 MHz) (M16C/26A, M16C/26B)			
		Vcc = 2.7 to 5.5 V (f(BCLK) = 10 MHz)			
		Vcc = 3.0 to 5.5 V (M16C/26T(T-ver.))			
		Vcc = 4.2 to 5.5 V (M16C/26T(V-ver.))			
	Power consumption	16 mA (Vcc = 5 V, f(BCLK) = 20 MHz)			
		25 μA (f(XCIN) = 32 KHz on RAM)			
		$3 \mu A$ (Vcc = $3 V$ , f(XCIN) = $32 KHz$ , in wait mode)			
		0.7 μA (Vcc = 3 V, in stop mode)			
Flash Memory	Programming /erasure	2.7 to 5.5 V (M16C/26A, M16C/26B)			
Version	voltage	3.0 to 5.5 V (M16C/26T(T-ver.)) 4.2 to 5.5 V (M16C/26T(V-ver.))			
	Programming /erasure	100 times (all area) or 1,000 times (block 0 to 3)			
	endurance	/ 10,000 times (block A, block B) <sup>(3)</sup>			
Operating Amb	ient Temperature	-20 to 85°C / -40 to 85°C <sup>(3)</sup> (M16C/26A , M16C/26B)			
	·	-40 to 85°C (M16C/26T(T-ver.))			
		-40 to 105°C / -40 to 125°C (M16C/26T(V-ver.))			
Package		48-pin plastic molded QFP			

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		. 11100/200.		) Ferrormance	40-FIII Fackage
		,			

NOTES:

1. I<sup>2</sup>C bus is a trademark of Koninklijke Philips Electronics N. V.

2. IEBus is a trademark of NEC Electronics Corporation.

- 3. See Table 1.7 Product Code for the program and erase endurance, and operating ambient temperature.
- 4. The PLL frequency synthesizer is used to run the M16C/26B at f(BCLK) = 24 MHz.

	Item	Performance				
CPU	Basic instructions	91 instructions				
	Minimun instruction	41.7 ns (f(BCLK) = 24 MHz <sup>(4)</sup> , VCC = 4.2 to 5.5 V (M16C/26B)				
	execution time	50 ns (f(BCLK) = 20 MHz, Vcc = 3.0 to 5.5 V) (M16C/26A, M16C/26B)				
		100 ns (f(BCLK) = 10 MHz, Vcc = 2.7 to 5.5 V) (M16C/26A, M16C/26B)				
	Operation mode	Single-chip mode				
	Address space	1M byte				
	Memory capacity	See 1.4 Product Information				
Peripheral	Port	33 I/O pins				
function	Multifunction timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 3 channels				
		Three-phase motor control timer				
	Serial I/O	1 channel (UART, clock synchronous serial I/O)				
		1 channel (UART, clock synchronous, I <sup>2</sup> C bus <sup>(1)</sup> , or IEBus <sup>(2)</sup> )				
	A/D converter	10 bit A/D converter: 1 circuit, 10 channels				
	DMAC	2 channels				
	CRC calcuration circuit	1 circuits (CRC-CCITT and CRC-16) with MSB/LSB selectable				
	Watchdog timer	15 bits x 1 channel (with prescaler)				
	Interrupt	18 internal and 8 external sources, 4 software sources,				
		Interrupt priority level: 7				
	Clock generation circuit	4 circuits				
		Main clock(*), Sub-clock(*)				
		On-chip oscillator, PLL frequency synthesizer				
		(*)Equipped with a built-in feedback resister.				
	Oscillation stop detection	Main clock oscillation stop, re-oscillation detection function				
	Voltage detection circuit	On-chip				
Electrical	Supply voltage	$V_{CC} = 4.2 \text{ to } 5.5 \text{ V} (f(BCLK) = 24 \text{ MHz})^{(4)}$ (M16C/26B)				
Characteristics		Vcc = 3.0 to 5.5 V (f(BCLK) = 20 MHz) (M16C/26A, M16C/26B)				
		Vcc = 2.7 to 5.5 V (f(BCLK) = 10 MHz)				
	Power Consumption	16 mA (Vcc = 5 V, f(BCLK) = 20 MHz)				
		$25 \mu\text{A}$ (f(XCIN) = 32 KHz on RAM)				
		3 μA (Vcc = 3 V, f(XCIN) = 32 KHz, in wait mode)				
		0.7 $\mu$ A (Vcc = 3 V, in stop mode)				
Flash memory	Programming/erasure	2.7 to 5.5 V				
	voltage					
	Programming/erasure	100 times (all area) or 1,000 times (block 0 to 3)				
	endurance	/ 10,000 times (block A, block B) <sup>(3)</sup>				
Operating Amb	bient Temperature	-20 to 85°C / -40 to 85°C <sup>(3)</sup>				
Package	· .	42-pin plastic molded SSOP				

Table 1.2. Performance outline of M16C/26A group (M16C/26A, M16C/26B) (42-pin device)

NOTES:

1.  $I^2C$  bus is a trademark of Koninklijke Philips Electronics N. V.

2. IEBus is a trademark of NEC Electronics Corporation.

3. See Table 1.7 Product Code for the program and erase endurance, and operating ambient temperature.

4. The PLL frequency synthesizer is used to run the M16C/26B at f(BCLK) = 24 MHz.

# 1.3 Block Diagram

Figure 1.1 and 1.2 show block diagrams of the M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) 48pin package and 42-pin package.



Figure 1.1 Block Diagram(48-pin Package)





Figure 1.2 Block Diagram( 42-pin Package)



## **1.4 Product List**

Tables 1.3 to 1.6 lists product information, Figure 1.3 shows a product numbering system, Table 1.7 lists the product code, and Figure 1.4 shows the marking.

#### Table 1.3 M16C/26A

#### Current as of Jul., 2006

Type Number		ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30260F3AGP	(N)	24K + 4K	1K			
M30260F6AGP	(N)	48K + 4K	2K	PLQP0048KB-A (48P6Q-A)		U3, U5, U7, U9
M30260F8AGP	(N)	64K + 4K	2K		Flash	
M30263F3AFP	(N)	24K + 4K	1K		memory	
M30263F6AFP	(N)	48K + 4K	2K	PRSP0042GA-B (42P2R)		U5, U9
M30263F8AFP	(N)	64K + 4K	2K			
M30260M3A-XXXGP	(N)	24K	1K			
M30260M6A-XXXGP	(N)	48K	2K	PLQP0048KB-A (48P6Q-A)		U3, U5
M30260M8A-XXXGP	(N)	64K	2K		Maak POM	
M30263M3A-XXXFP	(N)	24K	1K		IVIASK KOIVI	
M30263M6A-XXXFP	(N)	48K	2K	PRSP0042GA-B (42P2R)		U5
M30263M8A-XXXFP	(N)	64K	2K			

(N): New

#### Table 1.4 M16C/26B

#### Current as of Jul., 2006

Current as of Jul., 2006

Type Number		ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30260F8BGP (I	D)	64K + 4K	2K	PLQP0048KB-A (48P6Q-A)	Flash	U7
M30263F8BFP (D)		64K + 4K	2K	PRSP0042GA-B (42P2R)	memory	U9

(D): Under development

#### Table 1.5 M16C/26T T-ver.

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30260F3TGP	24K + 4K	1K			U3, U7
M30260F6TGP	48K + 4K	2K	PLQP0048KB-A (48P6Q-A)	Flash	
M30260F8TGP	64K + 4K	2K		memory	

NOTE:

1. Please contact Renesas Technolog Corp. for details on Mask ROM version.

#### Table 1.6 M16C/26T V-ver.

#### Current as of Jul., 2006

Type Number	ROM Capacity	RAM Capacity	Package	Remarks	Product Code
M30260F3VGP	24K + 4K	1K		Floop	U3, U7
M30260F6VGP	48K + 4K	2K	PLQP0048KB-A (48P6Q-A)	memory	
M30260F8VGP	64K + 4K	2K		mennory	

NOTE:

1. Please contact Renesas Technolog Corp. for details on Mask ROM version.





Figure 1.3 Product Numbering System



Product Code		Internal ROM (User Program Space)		Interna (Data	al ROM Space)	Operating Ambient
	Package	Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	Temperature
U3		100	0 to 60℃	100	0 to 60℃	-40 to 85℃
U5	Lead free	100				-20 to 85℃
U7		1 000		10.000	-40 to 85℃	-40 to 85℃
U9		1,000		10,000	-20 to 85℃	-20 to 85℃

#### Table 1.7 Product Code (Flash Memory Version) - M16C/26A, M16C/26B

#### Table 1.8 Product Code (Mask ROM Version - M16C/26A)

Product Code	Package	Operating Ambient Temperature
U3	Lood frog	-40℃ to 85℃
U5	Leau nee	-20℃ to 85℃

NOTE:

1. The lead contained products, D3, D5, D7, and D9 are put together with U3, U5, U7, and U9 respectively. Lead-free products can be mounted by both conventional Sn-Pb paste and Lead-free paste (Sn-Ag-Cu plating).

#### Table 1.9 Product Code (Flash Memory Version) - M16C/26T T-ver.

Product Code		Internal ROM (User Program Space)		Interna (Data	al ROM Space)	Operating Ambient
	Package	Programming and erasure endurance	Temperature range	Programming and erasure endurance	Temperature range	Temerature
U3	Load frog	100	000 to 6000	100	-40% to 85%	400C to 950C
U7	1,000		10,000	-4010 10 0510	-40 0 10 85 0	

#### Table 1.10 Product Code (Flash Memory Version) - M16C/26T V-ver.

Product Code		Internal ROM (User Program Space)		Interna (Data	al ROM Space)	Operating Ambient	
	Package	Programming and erasure endurance	Temperature range	Programming and erasure endurance	Temperature range	Temerature	
U3	Load froo	100	000 to 6000	100	-40°C to 125°C	40% to 125%	
U7	Leau liee	1,000		10,000	-40.0 10 120.0	-40°C 10 125°C	







# **1.5 Pin Assignments**

Figures 1.6 and 1.7 show the Pin Assignments (top view).



Figure 1.6 Pin Assignment for 48-Pin Package (Top View)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin
1		P92		TB2IN		AN32
2		P91		TB1IN		AN31
3		P90		ΤΒοιΝ	CLKout	AN30
4	CNVss					
5	XCIN	P87				
6	Хсоит	P86				
7	RESET					
8	Хоит					
9	Vss					
10	XIN					
11	Vcc					
12		P85	NMI	SD		
13		P84	INT <sub>2</sub>	ZP		
14		P83	INT <sub>1</sub>			
15		P82	INT <sub>0</sub>			
16		P81		TA4IN / Ū		
17		P80		TA40UT / U		
18		P77		ТАзіл		
19		P76		ТАзоит		
20		P75		TA2IN / W		
21		P74		TA20UT / W		
22		P73		TA1IN / V	CTS2 / RTS2 / TxD1	
23		P72		TA10UT / V	CLK2 / RXD1	
24		P71		TAOIN	RxD2 / SCL2 / CLK1	
25		P70		ΤΑοουτ	TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1	
26		P67			TxD1	
27		P66			RxD1	
28		P65			CLK1	
29		P64			RTS1 / CTS1/ CTS0 / CLKS1	
30		P63			TxDo	
31		P62			RxD0	
32		P61			CLK0	
33		P60			RTS0 / CTS0	
34		P17	INT <sub>5</sub>	IDU		
35		P16	INT <sub>4</sub>	IDW		
36		P15	ĪNT3	IDV		ADTRG
37		P107	Kl3			AN7
38		P106	Kl2			AN <sub>6</sub>
39		P105	KI1			AN5
40		P104	KIO			AN4
41		P103				AN3
42		P102				AN2
43		P101				AN1
44	AVss					
45		P100				AN0
46	Vref					
47	AVcc					
48		P93				AN24

Table 1.11 Pin Characteristics for 48-Pin Package





Figure 1.7 Pin Assignment for 42-Pin Package (Top View)



Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin
1	AVss					
2		P100				AN0
3	Vref					
4	AVcc					
5		P91		TB1IN		AN31
6		P90		ΤΒοιΝ	CLKout	AN30
7	CNVss					
8	XCIN	P87				
9	Хсоит	P86				
10	RESET					
11	Хоит					
12	Vss					
13	XIN					
14	Vcc					
15		P85	NMI	SD		
16		P84	INT <sub>2</sub>	ZP		
17		P83	INT <sub>1</sub>			
18		P82	INT <sub>0</sub>			
19		P81		TA4IN / Ū		
20		P80		TA40UT / U		
21		P77		ТАзіл		
22		P76		ТАзоит		
23		P75		TA2IN / W		
24		P74		TA20UT / W		
25		P73		TA1IN / V	CTS2 / RTS2 / TxD1	
26		P72		TA10UT / V	CLK2 / RxD1	
27		P71		TAOIN	RxD2 / SCL2 / CLK1	
28		P70		ΤΑθουτ	TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1	
29		P67			TxD1	
30		P66			RxD1	
31		P65			CLK1	
32		P64			RTS1 / CTS1/ CTS0 / CLKS1	
33		P17	INT <sub>5</sub>	IDU		
34		P16	INT <sub>4</sub>	IDW		
35		P15	INT <sub>3</sub>	IDV		ADTRG
36		P107	KI3			AN7
37		P106	KI2			AN6
38		P105	KI1			AN5
39		P104	KIO			AN4
40		P103				AN3
41		P102				AN2
42		P101				AN1

Table 1.12 Pin Characteristics for 42-Pin Package



## **1.6 Pin Description**

### Table 1.13 Pin Description (48-Pin and 42-Pin Packages)

Classification	Pin Name	I/O Type	Description
Power Supply	Vcc, Vss	I	Apply 0V to the Vss pin. Apply following voltage to the Vcc pin.
			2.7 to 5.5 V (M16C/26A, M16C/26B), 3.0 to 5.5 V (M16C/26T T-ver.), 4.2
			to 5.5 V (M16C/26T V-ver.)
Analog Power	AVcc	I	Supplies power to the A/D converter. Connect the AVcc pin to Vcc and
Supply	AVss		the AVss pin to Vss
Reset Input	RESET	I	The MCU is in a reset state when "L" is applied to the RESET pin
CNVSS	CNVss	I	Connect the CNVss pin to Vss
Main Clock	XIN	I	I/O pins for the main clock oscillation circuit. Connect a ceramic resonator
Input			or crystal oscillator between XIN and XOUT. To apply external clock, apply
Main Clock	Xout	0	it to XIN and leave XOUT open. If XIN is not used (for external oscillator or
Output			external clock), connect XIN pin to Vcc and leave Xout open
Sub Clock Input	XCIN	I	I/O pins for the sub clock oscillation circuit. Connect a crystal oscillator
Sub Clock Output	Хсоит	0	between XCIN and XCOUT
Clock Output	CLKOUT	0	Outputs the clock having the same frequency as f1, f8, f32, or fC
INT Interrupt	INTO to INT5	I	Input pins for the $\overline{\text{INT}}$ interrupt. $\overline{\text{INT2}}$ can be used for Timer A Z-phase
Input			function
NMI Interrupt	NMI	I	$\overline{\text{NMI}}$ interrupt input pin. $\overline{\text{NMI}}$ cannot be used as I/O port while the three-phase
Input			motor control is enabled. Apply a stable "H" to NMI after setting it's direction
			register to "0" when the three-phase motor control is enabled
Key Input Interrupt	KI0 to KI3	I	Input pins for the key input interrupt
Timer A	TA0OUT to	I/O	I/O pins for the timer A0 to A4
	ΤΑ4ουτ		
	TA0IN to	I	Input pins for the timer A0 to A4
	TA4IN		
	ZP	I	Input pin for Z-phase
Timer B	TB0IN to	I	Timer B0 to B1 input pins
	TB1IN		
Three-Phase	$\overline{U}, \overline{U}, \overline{V}, \overline{V}, \overline{V}, \overline{V}$	0	Output pins for the three-phase motor control timer
Motor Control	W, W		
Timer Output	IDU, IDW,	I/O	I/O pins for the three-phase motor control timer
	IDV, SD		
Serial I/O	CTS1 to CTS2	I	Input pins to control data transmission
	RTS1 to RTS2	0	Output pins to control data reception
	CLK1 to CLK2	I/O	Inputs and outputs the transfer clock
	RxD1 to RxD2	I	Inputs serial data
	TxD1 to TxD2	0	Outputs serial data
	CLKS1	0	Output pin for transfer clock
Reference	Vref	I	Applies reference voltage to the A/D converter
Voltage Input			
A/D Converter	AN <sub>0</sub> to AN <sub>7</sub>	I	Analog input pins for the A/D converter
	AN30 to AN31		
	ADTRG	I	Input pin for an external A/D trigger
I/O Ports	P15 to P17	I/O	I/O ports for CMOS. Each port can be programmed for input or output
			under the control of the direction register. An input port can be set, by
			program, for a pull-up resistor available or for no pull-up resister available
			in 3-bit units
	P64 to P67	I/O	I/O ports for CMOS. Each port can be programmed for input or output
	P70 to P77		under the control of the direction register. An input port can be set, by
	P80 to P87		program, for a pull-up resistor available or for no pull-up resister available
	P100 to P107		in 4-bit units
	P90 to P91		
		I/O · Input	and output

Classification	Pin Name	I/O Type	Description
Serial I/O	CTS0	I	Inputs pin to control data transmission
	RTS0	0	Output pin to control data reception
	CLK0	I/O	Inputs and outputs the transfer clock
	RxD0	I	Inputs serial data
	TxD0	0	Outputs serial data
Timer B	TB2IN	I	Timer B2 input pin
A/D Converter	AN24	I	Analog input pins for the A/D converter
	AN32		
I/O Ports	P60 to P63	I/O	I/O ports for CMOS. Each port can be programmed for input or output
	P92 to P93		under the control of the direction register. An input port can be set, by
			program, for a pull-up resistor available or for no pull-up resister available
			in 4-bit units
I : Input O : Output I/O : Input and output			

<b>Fable 1.13 Pin Description</b>	n ( 48-pin packages	only) (Continued)
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# 2. Central Processing Unit (CPU)

**Figure 2.1** shows the CPU registers. The register bank is comprised of seven registers (R0, R1, R2, R3, A0, A1 and FB) out of 13 registers. There are two sets of register bank.



### Figure 2.1. CPU Register

# 2.1 Data Registers (R0, R1, R2 and R3)

The R0 register consists of 16 bits, and is used mainly for transfers and arithmetic/logic operations. R1 to R3 are the same as R0.

The R0 register can be separated between high (R0H) and low (R0L) for use as two 8-bit data registers. R1H and R1L are the same as R0H and R0L. Conversely, R2 and R0 can be combined for use as a 32-bit data register (R2R0). R3R1 is the same as R2R0.

# 2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0.

In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).



# 2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

# 2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

# 2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

# 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits. Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

# 2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

# 2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

## 2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

### 2.8.2 Debug Flag (D Flag)

The D flag is used exclusively for debugging purpose. During normal use, it must be set to 0.

### 2.8.3 Zero Flag (Z Flag)

This flag is set to 1 when an arithmetic operation resulted in 0; otherwise, it is 0.

### 2.8.4 Sign Flag (S Flag)

This flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, it is 0.

#### 2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is 0; register bank 1 is selected when this flag is 1.

### 2.8.6 Overflow Flag (O Flag)

This flag is set to 1 when the operation resulted in an overflow; otherwise, it is 0.

### 2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is 0, and are enabled when the I flag is 1. The I flag is cleared to 0 when the interrupt request is accepted.

### 2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is 0; USP is selected when the U flag is 1.

The U flag is cleared to 0 when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

### 2.8.9 Processor Interrupt Priority Level (IPL)

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt is enabled.

#### 2.8.10 Reserved Area

When write to this bit, write 0. When read, its content is undefined.



# 3. Memory

**Figure 3.1** is a memory map of the M16C/26A Group (M16C/26A, M16C/26B, M16C/26T). The M16C/26A Group provides 1-Mbyte address space addresses 0000016 to FFFF16.

The internal ROM is allocated lower address, beginning with address FFFFF16. For example, a 64-Kbyte internal ROM area is allocated in addresses F000016 to FFFF16. The flash memory version has two sets of 2-Kbyte internal ROM area, block A and block B, for data space. These blocks are allocated addresses F00016 to FFFF16.

The fixed interrupt vectors are allocated addresses FFFDC16 to FFFFF16 and they store the start address of each interrupt routine.

The internal RAM is allocated higher addresses, beginning with address 0040016. For example, a 1-Kbyte internal RAM area is allocated in addresses 0040016 to 007FF16. The internal RAM is used for temporarily storing data. The area is also used as stacks when subroutines are called or interrupt requests are acknowledged.

The SFR is allocated addresses 0000016 to 003FF16. The peripheral function control registers are allocated here. All blank spaces within SFR location are reserved and cannot be accessed by users.

The special page vectors are allocated addresses FFE0016 to FFFDB16. They are used for the JMPS instruction and JSRS instruction. Refer to the Renesas publication **M16C/60 and M16C/20 Series Software Manual** for details.



Figure 3.1 Memory Map



# 4. Special Function Register (SFR)

### Table 4.1 SFR Information(1)<sup>(1)</sup>

Address	Register	Symbol	After reset
000016			
000116			
000216			
000316			
000416	Processor mode register 0	PM0	0016
000516	Processor mode register 1	PM1	000010002
000616	System clock control register 0	CM0	010010002(M16C/26A)
	Quatant als als a start as nister 4	0144	011010002(M16C/26T)
000716		CIVIT	00100002
000016	Addross match interrupt anable register	AIED	XXXXXX002
000316	Protect register		XX0000002
000R16		FROM	XX0000002
000C16	Oscillation stop detection register <sup>(2)</sup>	CM2	0X000002
000D16		0.112	0,0000002
000E16	Watchdog timer start register	WDTS	XX16
000F16	Watchdog timer control register	WDC	00XXXXX2 <sup>(3)</sup>
001016	Address match interrupt register 0	RMAD0	0016
001116			0016
001216			X016
001316			
001416	Address match interrupt register 1	RMAD1	0016
001516			0016
001616			X016
001716			
001816		1/054	000010000
001916	Voltage detection register 1 (4, 5)	VCR1	000010002
001R16		VCR2	0016
001016	PLL control register 0	PI CO	0001X0102
001D16		1 200	0001/0102
001E16	Processor mode register 2	PM2	XXX000002
001F16	Low voltage detection interrupt register <sup>(5)</sup>	D4INT	0016
002016	DMA0 source pointer	SAR0	XX16
002116			XX16
002216			XX16
002316			
002416	DMA0 destination pointer	DAR0	XX16
002516			XX16
002616			XX16
002716			
002816	DMA0 transfer counter	TCR0	XX16
002916			XX16
002A16			
002B16	DMA0 control register	DMOCON	00000X002
002016		DIVIDCON	000007002
002D16			
002E16			
003016	DMA1 source pointer	SAR1	XX16
003116			XX16
003216			XX16
003316			
003416	DMA1 destination pointer	DAR1	XX16
003516			XX16
003616			XX16
003716			
003816	DMA1 transfer counter	TCR1	XX16
003916			XX16
003A16			
003B16	DMA1 control register	DM1CON	000002002
003016		DIVITCON	00000002
003D16			
003E16			
003F16			

NOTES:

The blank spaces are reserved. No access is allowed.
 Bits CM27, CM21, and CM20 do not change at oscillation stop detection reset.

The WDC5 bit is 0 (cold start) immediately after power-on. It can only be set to 1 by program. The WDC5 bit cannot be used in M16C/26T.

4. The VCR1 and VCR2 registers do not change at software reset, watchdog timer reset, and oscillation stop detection reset.

5. Registers VCR1, VCR2, and D4INT cannot be used in M16C/26T.

X : Undefined



### Table 4.2 SFR Information(2)<sup>(1)</sup>

Address	Register	Symbol	After reset
004016	riogioto.	• • • • • • • • • • • • • • • • • • • •	
004116			
004216			
004316			
004416	INT3 interrupt control register	INT3IC	XX00X0002
004516			
004616			
004716			
004816	INT5 interrupt control register	INT5IC	XX00X0002
004916	INT4 interrupt control register	INT4IC	XX00X0002
004A16	UART2 Bus collision detection interrupt control register	BCNIC	XXXXX0002
004B16	DMA0 interrupt control register	DM0IC	XXXXX0002
004C16	DMA1 interrupt control register	DM1IC	XXXXX0002
004D16	Key input interrupt control register	KUPIC	XXXXX0002
004E16	A/D conversion interrupt control register	ADIC	XXXXX0002
004F16	UAR12 transmit interrupt control register	S21IC	XXXXX0002
005016	UAR 12 receive interrupt control register	S2RIC	XXXXX0002
005116	UAR I 0 transmit interrupt control register	SUTIC	XXXXX0002
005216	UAR TO receive interrupt control register	SURIC	XXXXX0002
005316		S111C	XXXXX0002
005540			XXXX0002
005516			
005716	TimerA2 interrupt control register		
005816	TimerA3 interrupt control register		XXXXX0002 XXXXX0002
005916	TimerA4 interrupt control register	TA4IC	XXXXX0002
005A16	TimerB0 interrupt control register	TB0IC	XXXXX0002
005B16	TimerB1 interrupt control register	TB1IC	XXXXX0002
005C16	TimerB2 interrupt control register	TB2IC	XXXXX0002
005D16	INT0 interrupt control register	INTOIC	XX00X0002
005E16	INT1 interrupt control register	INT1IC	XX00X0002
005F16	INT2 interrupt control register	INT2IC	XX00X0002
006016			
006116			
006216			
006316			
006416			
006516			
006616			
006716			
006816			
006916			
006P40			
006040			
006D16			
006E16			
006F16			
007016			
007116			
007216			
007316			
007416			
007516			
007616			
007716			
007816			
007916			
007A16			
007B16			
007C16			
007D16			
007E16			
UU/F16			

NOTE:

1. Blank spaces are reserved. No access is allowed. X: Undefined



# Table 4.3 SFR Information(3)<sup>(1)</sup>

Address	Register	Symbol	After reset
008016			
008116			
008216			
008316			
008416			
008516			
000018			
≈			
01B016			
01B116			
01B216	Floop memory control register 4 (Note 2		01000000
01B316	Flash memory control register 4 (Note 2		01000002
01B516	Elash memory control register 1 (Note 2	) FMR1	000XXX0X2
01B616			000/////0//2
01B716	Flash memory control register 0 (Note 2	) FMR0	0116
01B816			
01B916			
01BA16			
018816			
01BD16			
01BE16			
01BF16			
₹			
025016			
025116			
025216			
025316			
025516			
025616			
025716			
025816			
025916			
025A16	Three phase protect control register	TPRC	0016
025B16		DOOD	00000404-
025016	On-chip oscillator control register		000001012
025E16	Peripheral clock select register	PCI KR	00000112
025F16		- I OERIK	00000112
≈ ∣			
0000			
033016			
033216			
033316			
033416			
033516			
033616			
033716			
033816			
033916			
033R16			
033C16			
033D16			
033E16	NMI digital debounce register	NDDR	FF16
033F16	Port17 digital debounce register	P17DDR	FF16
NOTES			

NOTES:

1. Blank spaces are reserved. No access is allowed.

2. This register is included in the flash memory version.

X: Undefined



### Table 4.4 SFR Information(4)<sup>(1)</sup>

Address	Register	Symbol	After reset
034016			
034116			
034216	Timor A1-1 register	ΤΛ11	XX1c
034316			XX16
034416	Timer A2-1 register	ΤΔ21	XX16
034516		1721	XX16
034616	Timer Δ4-1 register	ΤΔ41	XX16
034716			XX16
034816	Three phase PWM control register 0		0016
034916	Three phase PWM control register 0		0016
034416	Three phase e will control register 1		3E10
034B16	Three phase output buffer register 0		3E10
034C16	Doad time timer		
034D16	Timor B2 Interrupt occurrence frequency set counter		
034E16	Position-data-rotain function control register		
034E10	rosition-data-retain function control register	FDRI	XXX00002
035016			
035116			
035216			
035316			
035416			
025540			
035516			
035016			
035716	Dert function control register	DECD	00111111
035016	Port function control register	PFCR	00111112
035916			
035A16			
035016			
035016			
035D16		150004	
035E16	Interrupt request cause select register 2	IFSR2A	
030F16	interrupt request cause select register	IFSR	0016
036016			
036116			
036216			
036316			
036416			
036516			
036616			
036716			
036816			
036916			
036A16			
036B16			
036016			
036016			
026510			
0370			
037016			
037116			
037216			
037316	LIAPT2 appoint mode register 4		0040
03751	UART2 special mode register 2		
037516	UART2 special mode register 2		
037016	UART2 special mode register		X0000002
037716			
03/816	UAR IZ transmit/receive mode register		UU16
037916		UZBKG	
03/A16	UAR 12 transmit dutter register	UZIB	
037B16			XXXXXXXX2
037C16	UAR I 2 transmit/receive control register 0	02C0	000010002
037D16	UAR 12 transmit/receive control register 1	0201	
037E16	UAR 12 receive butter register	U2RB	
037F16			XXXXXXXX2

NOTE: 1. Blank spaces are reserved. No access is allowed. X : Undefined



# Table 4.5 SFR Information(5)<sup>(1)</sup>

Address	Register	Symbol	After reset
038016	Count start flag	TABSR	0016
038116	Clock prescaler reset flag	CPSRF	0XXXXXXX2
038216	One-shot start flag	ONSF	0016
038316	Trigger select register	TRGSR	0016
038416	Up-dowm flag	UDF	0016
038516			
038616	Timer A0 register	TA0	XX16
038716			XX16
038816	Timer A1 register	TA1	XX16
038916	<b>T</b> 10 17	<b>-</b> 10	XX16
038A16	limer A2 register	TA2	XX16
038B16	<b>T A</b> O <b>1 1</b>	<b>T</b> 10	XX16
038C16	limer A3 register	TA3	XX16
038D16	Timer A A an aintea	TA 4	XX16
038E16	limer A4 register	IA4	XX16
030F16	Timer D0 versister	тро	XX16
039016	Timer Bo register	IBU	
030246	Timor P1 register	TD1	
039216			
039316	Timor P2 register	тро	
039516			XX10 XX16
039616	Timer A0 mode register		0016
039716	Timer A1 mode register		0016
039816	Timer A2 mode register	TA2MR	0016
039916	Timer A3 mode register	TA3MR	0016
039A16	Timer A4 mode register	TA4MR	0016
039B16	Timer B0 mode register	TBOMR	00XX00002
039C16	Timer B1 mode register	TB1MR	00XX00002
039D16	Timer B2 mode register	TB2MR	00XX00002
039E16	Timer B2 special mode register	TB2SC	X0000002
039F16			
03A016	UART0 transmit/receive mode register	U0MR	0016
03A116	UART0 bit rate register	U0BRG	XX16
03A216	UART0 transmit buffer register	U0TB	XXXXXXXX2
03A316			XXXXXXXX2
03A416	UART0 transmit/receive control register 0	U0C0	000010002
03A516	UART0 transmit/receive control register 1	U0C1	000000102
03A616	UART0 receive buffer register	UORB	XXXXXXXX2
03A716			XXXXXXXX2
03A816	UART1 transmit/receive mode register	U1MR	0016
03A916	UART1 bit rate register	U1BRG	XX16
03AA16	UART1 transmit buffer register	U1TB	XXXXXXXX2
03AB16			XXXXXXXX2
03AC16	UARI1 transmit/receive control register 0		000010002
03AD16	UAR I 1 transmit/receive control register 1		00000102
03AE16	UARIT receive butter register	UIKB	ΧΧΧΧΧΧΧΧ2
03AF16			<u>XXXXXXXX</u> 2
038140	UAK L transmit/receive control register 2		XUUUUUUU2
03B216			
03B316			
03B416	CRC snoon address register	CRCSAR	XX16
03B516	ono shoop address register		00XXXXXX2
03B616	CRC mode register	CRCMR	0XXXXXX02
03B716			0//////////////////////////////////////
03B816	DMA0 request cause select register	DM0SI	0016
03B916			
03BA16	DMA1 request cause select register	DM1SI	0016
03BB16	· · · · · · · · · · · · · · · · · · ·		
03BC16	CRC data register	CRCD	XX16
03BD16			XX16
03BE16	CRC input register	CRCIN	XX16
03BF16	-		

NOTE:

1. Blank spaces are reserved. No access is allowed.

X : Undefined

#### Address Register Symbol After Reset 03C016 A/D register 0 AD0 XXXXXXXX2 XXXXXXXX2 03C116 AD1 03C216 A/D register 1 XXXXXXXXX2 XXXXXXXX2 03C316 A/D register 2 AD2 03C416 XXXXXXXX2 XXXXXXXX2 03C516 A/D register 3 AD3 03C616 XXXXXXXX2 03C716 XXXXXXXX2 03C816 A/D register 4 AD4 XXXXXXXX2 XXXXXXXX2 03C916 03CA16 A/D register 5 AD5 XXXXXXXX2 03CB16 XXXXXXXX2 A/D register 6 AD6 XXXXXXXX2 03CC16 XXXXXXXX2 03CD16 A/D register 7 AD7 XXXXXXXX2 03CE16 XXXXXXXX2 03CF16 03D016 03D116 03D216 A/D trigger control register ADTRGCON 0016 00000X002 ADSTAT0 03D316 A/D status register 0 ADCON2 A/D control register 2 0016 03D416 03D516 A/D control register 0 ADCON0 00000XXX2 03D616 ADCON1 03D716 A/D control register 1 0016 03D816 03D916 03DA16 03DB16 03DC16 03DD16 03DE16 03DF16 03E016 Port P1 register P1 XX16 03E116 03E216 03E316 Port P1 direction register PD1 0016 03E416 03E516 03E616 03E716 03E816 03E916 03EA16 03EB16 03EC16 Port P6 register P6 XX16 Port P7 register P7 XX16 03ED16 03EE16 Port P6 direction register PD6 0016 03EF16 Port P7 direction register PD7 0016 03F016 Port P8 register P8 XX16 Port P9 register **P**9 XXXXXXXX2 03F116 03F216 Port P8 direction register PD8 0016 PD9 Port P9 direction register XXXX00002 03F316 Port P10 register P10 03F416 XX16 03F516 Port P10 direction register **PD10** 0016 03F616 03F716 03F816 03F916 03FA16 03FB16 PUR0 0016 03FC16 Pull-up control register 0 03FD16 Pull-up control register 1 PUR1 0016 03FE16 Pull-up control register 2 PUR2 0016 03FF16 Port control register PCR 0016

#### Table 4.6 SFR Information(6)<sup>(1)</sup>

NOTE:

1. Blank spaces are reserved. No access is allowed.

X: Undefined





# **REVISION HISTORY**

M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) Shortsheet

Rev. Date			Description
		Page	Summary
0.51	07/25/06	-	First edition

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